

SEMICONDUCTOR IM

### **General Description:**

Half watt, General purpose, Medium Current Surface Mount Zener in the SOD-123 package. The SOD-123 package has the same footprint as the glass mini-melf (LL-34) package & provides a convenient alternative to the Leadless package.

# Features:

• Compact surface mount with same footprint as mini-melf

**DISCRETE POWER AND SIGNAL** 

**TECHNOLOGIES** 

- 500 mW rating on FR-4 or FR-5 board.
- Class 3 ESD rating (>16 kV) per Human Body Model

### **Ordering:**

**MMSZ5247B** 

**5% TOLERANCE** 

• 7 inch reel (178 mm); 8 mm Tape; 3,000 units per reel.

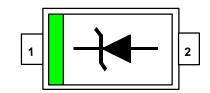
# Absolute Maximum Ratings (note 1) TA = 25°C unless otherwise noted

Parameter	Value	Units
Storage Temperature	-55 to +150	°C
Maximum Junction Temperature	-55 to +150	OO
Total Power Dissipation at 25 <sup>0</sup> C	500	mW
Derate above 25 <sup>0</sup> C	6.7	mW/ <sup>o</sup> C
Thermal Resistance ( $R_{\emptyset JA}$ ) Junction to Ambient (note 2)	340	°C/W
Maximum Temperature Coefficient	0.084	%/ <sup>o</sup> C
Nominal Zener Voltage (V <sub>z</sub> ) at 7.4 mA	17.0	V

Note 1: These ratings are limiting values above which the serviceability of any semiconductor device may be impaired

Note 2: FR-4 or FR-5 =  $3.5 \times 1.5$  inches using minimum recommended Land Pads.

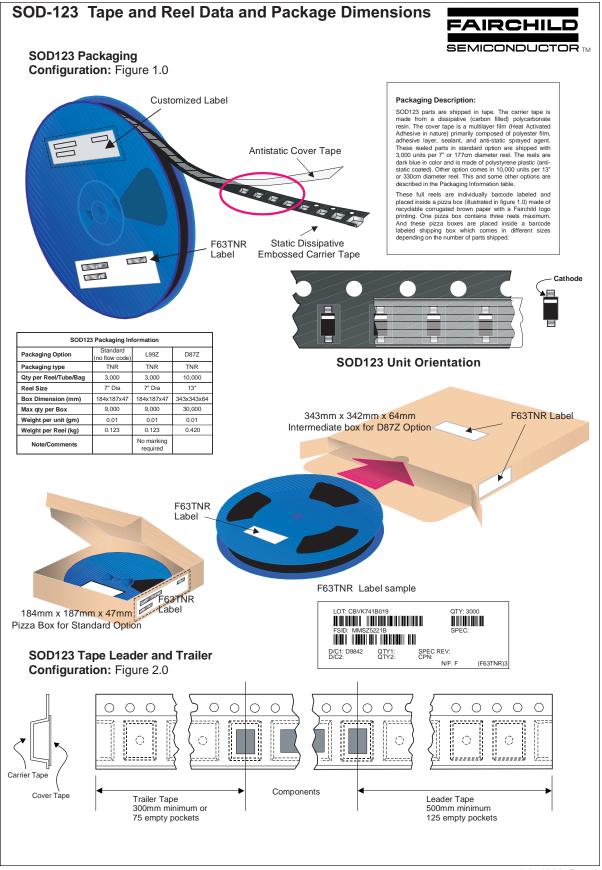
Top Mark: **J2** 1: Cathode 2: Anode



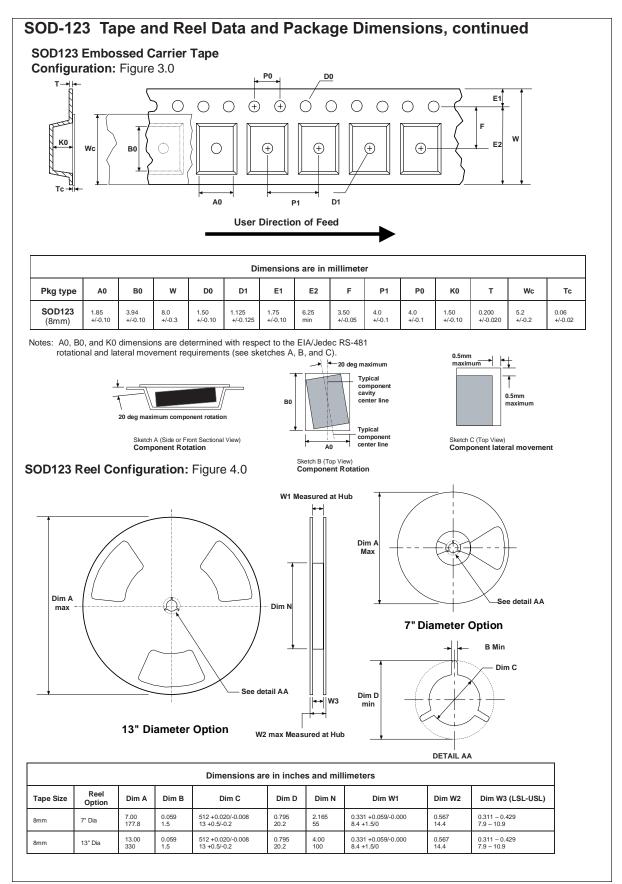
## **Electrical Characteristics** TA = 25°C unless otherwise noted

SYM	CHARACTERISTICS	MIN	МАХ	UNITS	TEST CONDITIONS
Vz	Zener Voltage	16.15 15.97	17.85 17.41	V V	$I_{ZT} = 7.4 \text{ mA D.C.}$ $I_{ZT} = 7.4 \text{ mA Pulse 26 mS}$
Zz	Zener Impedance		19.0	Ohms	I <sub>ZT</sub> = 7.4 mA
Z <sub>ZK</sub>	Zener Knee Impedance		600	Ohms	I <sub>ZK</sub> = 250 uA
I <sub>R</sub>	Reverse Leakage		100	nA	V <sub>R</sub> = 13.0 V
V <sub>F</sub>	Forward Voltage		900	mV	I <sub>F</sub> = 10 mA

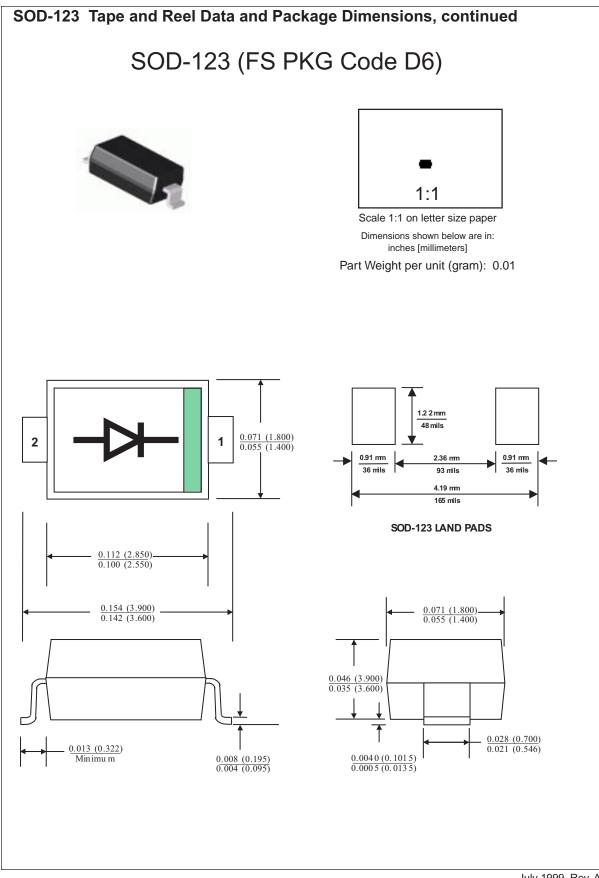
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Definition of Terms

Datasheet Identification	Product Status	Definition
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